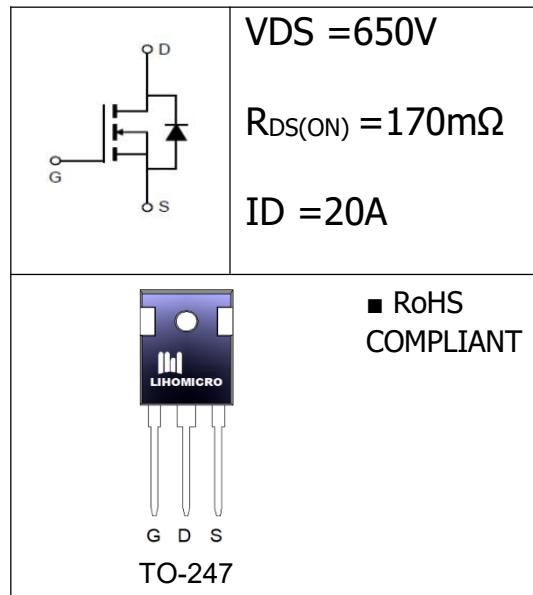


•General Description

The SJ MOSFET LH65R170 has the low $R_{DS(on)}$, low gate charge, fast switching and excellent avalanche characteristics. This device offers extremely fast and robust body diode, and is suitable for telecom and power supplies.



•Features

- Much lower Ron*A performance for On-state efficiency
- Much lower FOM for fast switching efficiency

•Application

- LED/LCD/PDP TV and monitor Lighting
- Solar/Renewable/UPS-Micro Inverter System
- Power Supplies

•Ordering Information:

Part number	LH65R170	
Package	TO-247	
Basic ordering unit (pcs)	330	
Normal Package Material Ordering Code	LH65R170T2-TO247-TU	
Halogen Free Ordering Code	LH65R170T2-TO247-TU-HF	

•Absolute Maximum Ratings (TC =25°C)

PARAMETER	SYMBOL	Value		UNIT
Drain-Source Breakdown Voltage	BV _{DSS}	650		V
Gate-Source Voltage	V _{GS}	±30		V
Continuous Drain Current TC = 25°C TC = 100°C	I _D	20		A
		12		
Pulsed drain current (TC = 25°C, tp limited by Tjmax) ¹	I _D pulse	60		A
Single Pulse Avalanche Energy ¹	I _{AR}	3.5		A
Single Pulse Avalanche Energy ²	E _{AS}	484		mJ
Repetitive Avalanche Energy ¹	E _{AR}	0.7		mJ
Power Dissipation(TC=25°C)	P _D	TO-220:151	TO-220F:34	W
Operating Temperature and Storage Temperature Range	T _J /T _{STG}	-55~+150		°C
MOSFET dv/dt ruggedness, V _{DS} =0...480V	dv/dt	50		V/ns
Reverse diode dv/dt, V _{DS} =0...480V,I _{SD} ≤I _D	dv/dt	15		V/ns

•Electronic Characteristics

PARAMETER	SYMBOL	TEST CONDITION	MIN	TYP	MAX	UNIT
Drain-Source Breakdown Voltage	BV_{DSS}	$V_{GS} = 0V, I_D = 250\mu A$	650	--	--	V
Gate Threshold Voltage	$V_{GS(TH)}$	$V_{DS} = V_{GS}, I_D = 250\mu A$	2.5	--	4.5	V
Drain-source On Resistance ³	$R_{DS(ON)}$	$V_{GS} = 10V, I_D = 7.5A$	--	0.15	0.17	Ω
Drain-Source Leakage Current	I_{DSS}	$V_{DS} = 650V, V_{GS} = 0V, T_J = 25^\circ C$	--	--	1	uA
		$V_{DS} = 650V, V_{GS} = 0V, T_J = 125^\circ C$	--	--	100	
Gate-Source Leakage Current	I_{GSS}	$V_{GS} = \pm 30$	--	--	± 100	nA
Forward Transconductance ³	R_G	f=1.0MHz open drain	--	--	12	Ω
Input Capacitance	C_{iss}	$V_{GS} = 0V, V_{DD} = 520V$ $f = 1.0MHz$	--	1724	--	pF
Output Capacitance	C_{oss}		--	61	--	
Reverse transfer Capacitance	C_{rss}		--	6	--	
Turn-on delay time	$T_{d(on)}$	$I_D = 20A, V_{DD} = 400V$ $R_G = 25\Omega$	--	15	--	nS
Rise time	T_r		--	59	--	
Turn -Off Delay Time	$T_{d(off)}$		--	121	--	
Fall time	T_f		--	44	--	
Total Gate Charge	Q_g	$I_D = 20A, V_{DS} = 520V$ $V_{GS} = 10V$	--	38.5	--	nC
Gate-to-Source Charge	Q_{gs}		--	8	--	
Gate-to-Drain Charge	Q_{gd}		--	15	--	
Continuous Diode Forward Current	I_s		--	--	20	A
Pulsed Diode Forward Current	I_{SM}		--	--	60	A
Diode Forward Voltage	V_{SD}	$T_J = 25^\circ C, I_s = 20A$ $V_{GS} = 0V$	--	0.9	1.2	V
Reverse Recovery Time	t_{rr}	$V_{RR} = 400V, I_f = I_s$ $dI_f/dt = 100A/\mu s$	--	423	--	ns
Reverse Recovery Charge	Q_{rr}		--	5.3	--	uC
Peak Reverse Recovery Current	I_{RRM}		--	25	--	A

•Thermal Characteristics

PARAMETER	SYMBOL	MAX		UNIT
		TO-220F	TO-220	
Thermal Resistance Junction-case	R_{thJC}	3.7	0.83	°C/W
Thermal Resistance Junction-ambient	R_{thJA}	80	62	°C/W

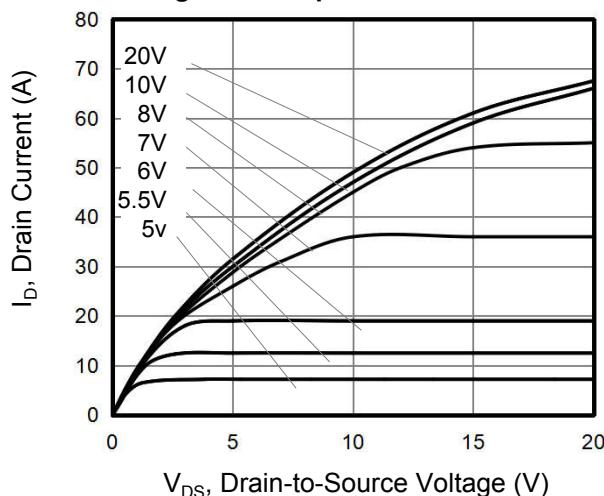
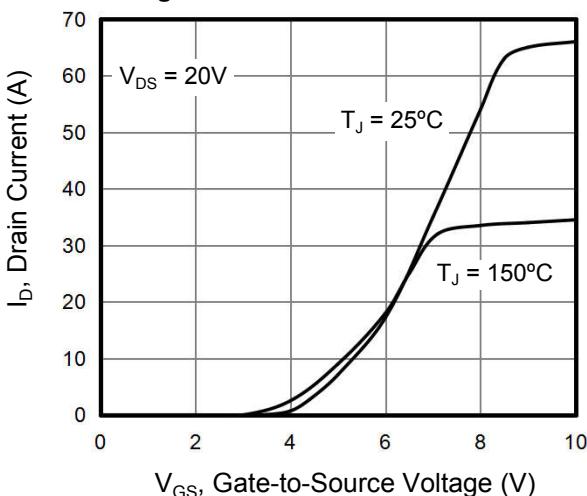
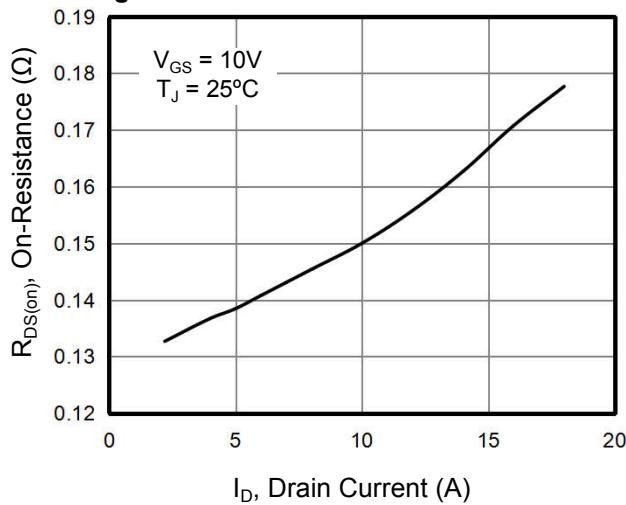
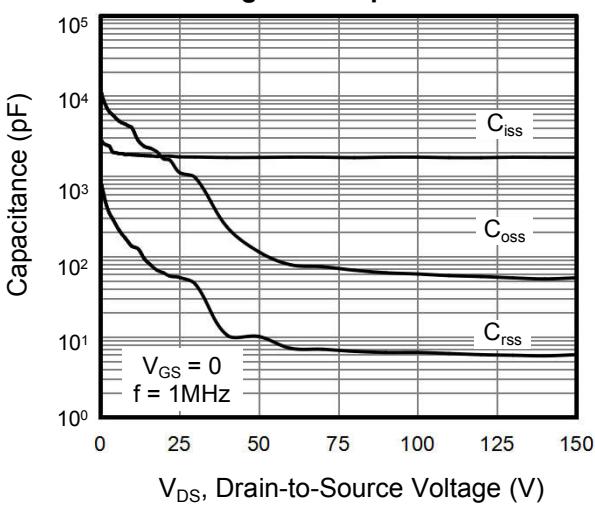
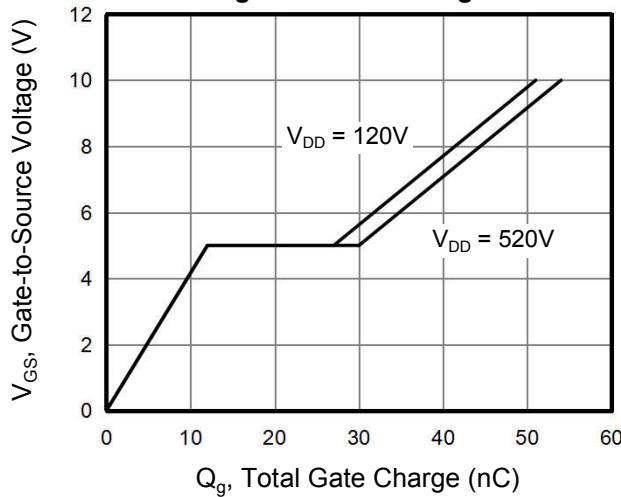
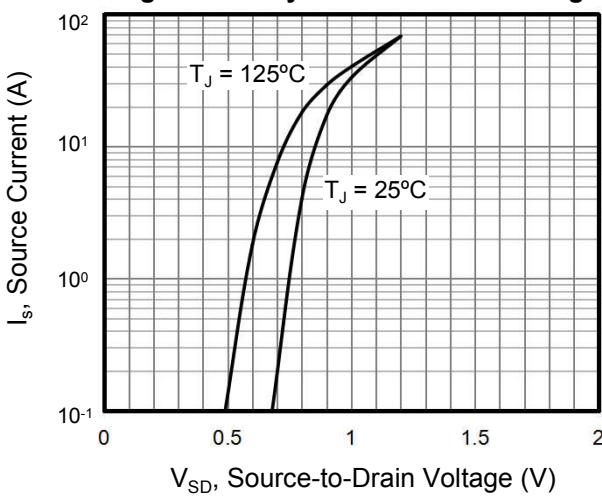
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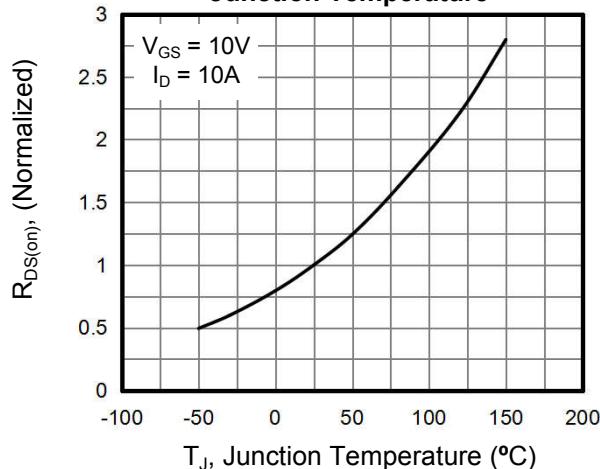
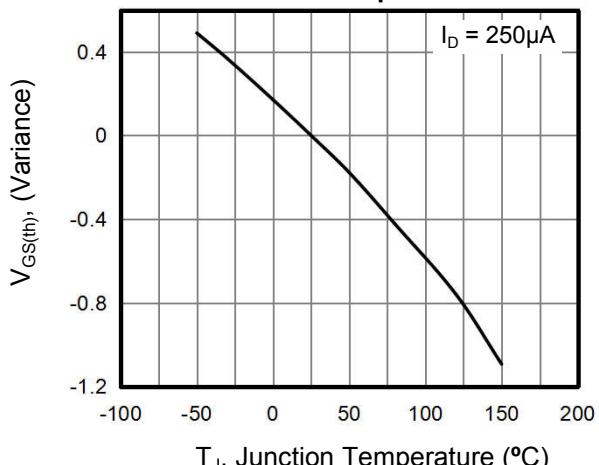
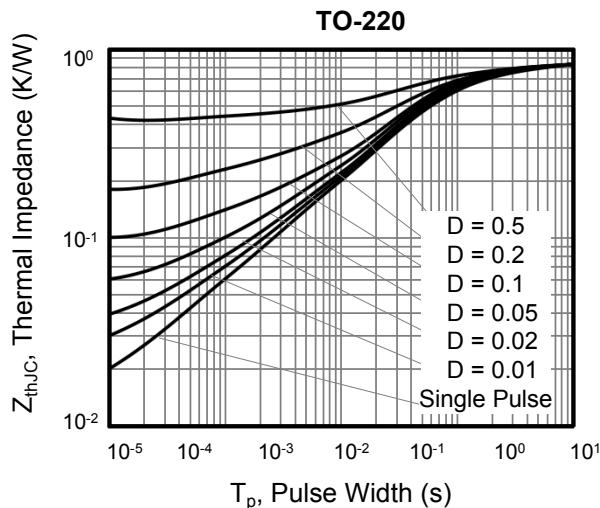
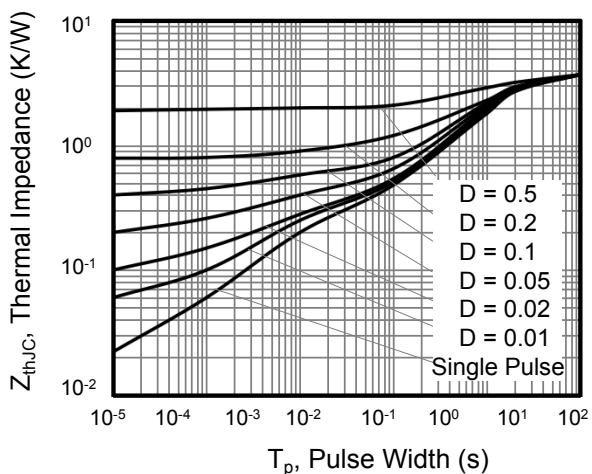
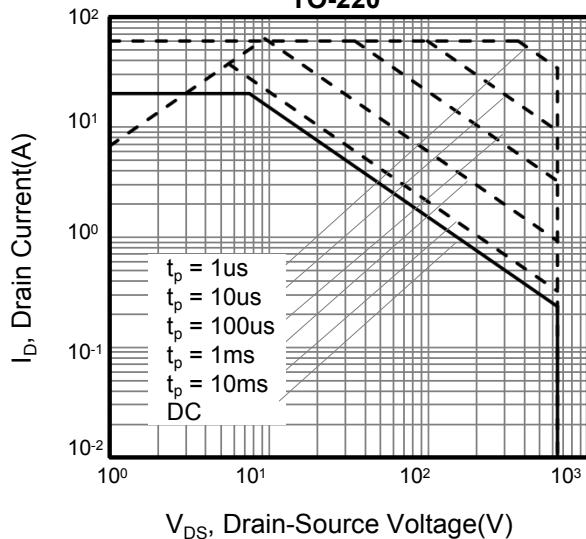
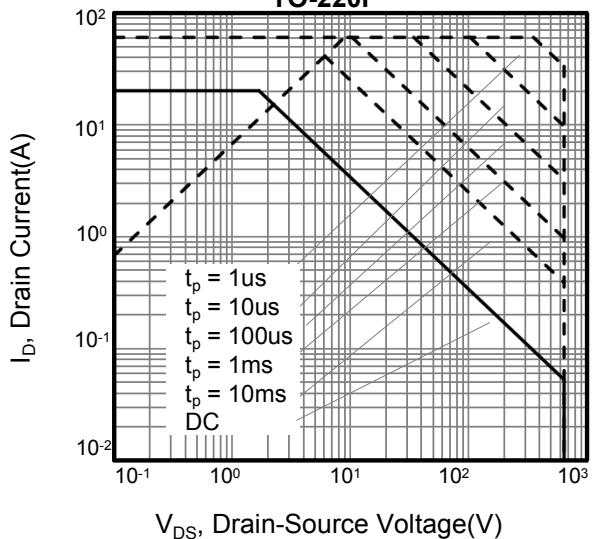
1. Repetitive Rating: Pulse width limited by maximum junction temperature.

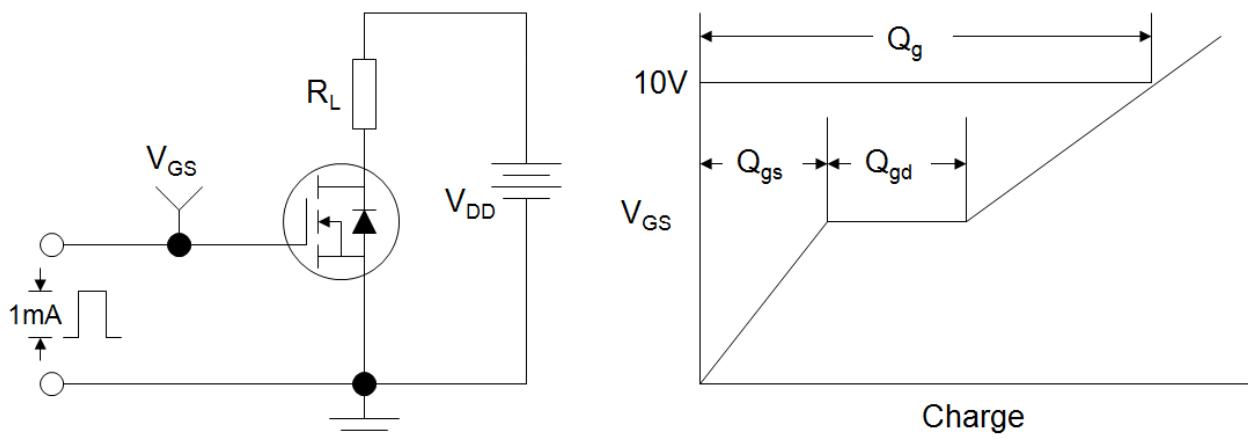
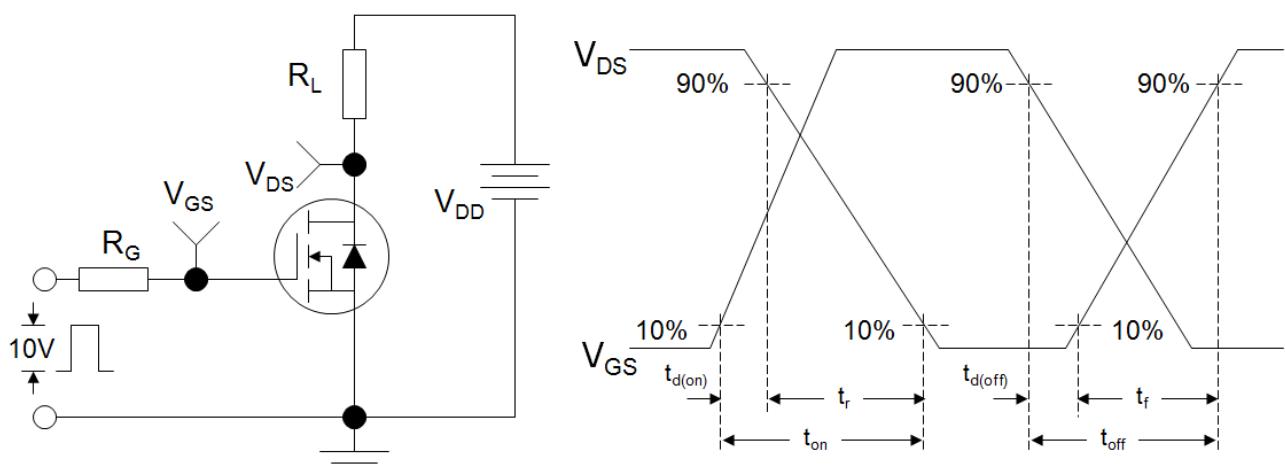
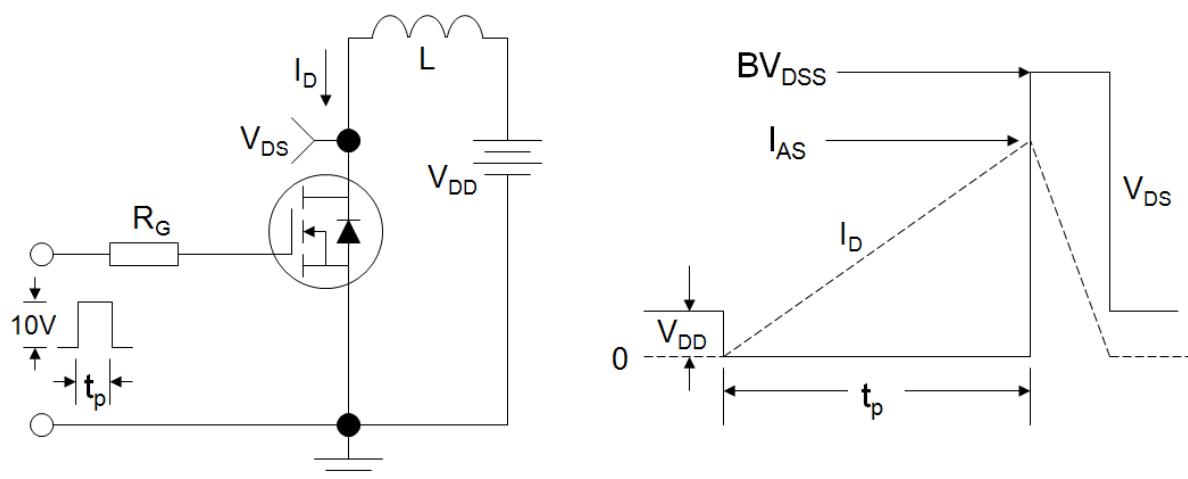
2. $I_{AS} = 1.8A, V_{DD} = 50V, R_G = 25\Omega$, Starting $T_J = 25^\circ C$

3. Pulse Test : Pulse width $\leq 300\mu s$, Duty cycle $\leq 2\%$

- **Typical Characteristics** $T_J=25^\circ\text{C}$, unless otherwise noted

Figure 1. Output Characteristics

Figure 2. Transfer Characteristics

Figure 3. On-Resistance vs. Drain Current

Figure 4. Capacitance

Figure 5. Gate Charge

Figure 6. Body Diode Forward Voltage


•Typical Characteristics(Cont.)
Figure 7. On-Resistance vs. Junction Temperature

Figure 8. Threshold Voltage vs. Junction Temperature

Figure 9. Transient Thermal Impedance TO-220

Figure 10. Transient Thermal Impedance TO-220F

Figure 12. Safe operation area for TO-220

Figure 13. Safe operation area for TO-220F


•Test Circuit and Waveform
Figure A: Gate Charge Test Circuit and Waveform

Figure B: Resistive Switching Test Circuit and Waveform

Figure C: Unclamped Inductive Switching Test Circuit and Waveform


•Dimensions (TO-247)

UNIT:mm

SYMBOL	min	max	SYMBOL	min	max
A	15.60	16.00	G2	1.95	2.25
B	20.80	21.20	N	5.25	5.65
C	4.85	5.15	L1	4.00	4.30
D	1.85	2.15	L	19.60	20.40
E	1.00	1.40	I	2.30	2.50
F	0.50	0.70	ΦP	3.30	3.70
G1	3.00	3.30			

